



PATENT

IN THE UNITED STATES PATENT
AND TRADEMARK OFFICE

Applicants: Yao et al.

Serial No.: 10/674,370

Filed: September 30, 2003

For: Circuit Package and Method of Plating
the Same


Attorney Docket No.: 30320/15636

Group Art Unit: Not Yet Assigned

Examiner: Not Yet Assigned

) I hereby certify that this paper is
) being deposited with the United
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) Commissioner for Patents, P.O.
) Box 1450, Alexandria, Virginia
) 22313-1450 on this date:

) January 15, 2004

) 
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) Attorney for Applicants
)

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Pursuant to 37 CFR 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached Form PTO-1449. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

Copies of all non-U.S. patent documents on the PTO-1449 form are attached.

In accordance with 37 CFR 1.97(g), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 CFR 1.56(a) exists. In accordance with 37 CFR 1.97(h), the filing of this Information Disclosure statement shall not be construed to be an admission that any patent, publication or other information referred to therein is "prior art" for this invention unless specifically designated as such.

TIME OF FILING

This information disclosure statement is being filed, to the best of the undersigned's knowledge, before the mailing date of a first Office action on the merits. In accordance with 37 CFR §1.97(b), no certification or fee is required.

METHOD OF PAYMENT

It is submitted that the Information Disclosure Statement is in compliance with 37 CFR 1.98 and the Examiner is respectfully requested to consider the listed references.

The Director is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 13-2855, under Order No. 29757/P-800. A duplicate copy of this paper is enclosed.

Dated: January 15, 2004

Respectfully submitted,

By 

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For PTO-1449 (Modified)	U.S. Department of Commerce Patent and Trademark Office	Atty. Docket No. 30320/15636	Serial No. 10/674,370
INFORMATION DISCLOSURE STATEMENT		Applicant Yao et al.	
		Filing Date 09/30/2003	Group Not Yet Assigned

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)		
		"Thermal VIA/BGA", Micro Substrates Corporation, website, 3 pages, © 2000, found at: http://www.microsubstrates.com/body_thermal%20via_bga.html .
		Technical Schematic entitled "Modification of Ceramic Detail, Thickness & Base," dated 1/29/2003, Kyocera Corporation.

Examiner	Date Considered
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	